# **Four-Bit Universal Shift Register**

#### Description

The MC10H141 is a four-bit universal shift register. This device is a functional/pinout duplication of the standard MECL  $10K^{\text{TM}}$  part with 100% improvement in propagation delay and operation frequency and no increase in power supply current.

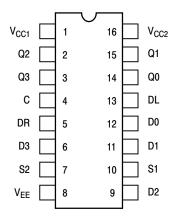
#### **Features**

- Shift frequency, 250 MHz Min
- Power Dissipation, 425 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available\*

**Table 1. TRUTH TABLE** 

SELECT		OPERATING	OUTPUTS				
S1	S2	MODE	Q0 <sub>n + 1</sub>	Q1 <sub>n+1</sub>	Q2 <sub>n + 1</sub>	Q3 <sub>n + 1</sub>	
L	L	Parallel Entry	D0	D1	D2	D3	
L	Ι	Shift Right*	Q1 <sub>n</sub>	Q2 <sub>n</sub>	Q3 <sub>n</sub>	DR	
Н	ш	Shift Left*	DL	Q0 <sub>n</sub>	Q1 <sub>n</sub>	Q2 <sub>n</sub>	
Н	Ι	Stop Shift	Q0 <sub>n</sub>	Q1 <sub>n</sub>	Q2 <sub>n</sub>	32 <sub>n</sub>	

Outputs as exist after pulse appears at "C" input with input conditions as shown (Pulse Positive transition of clock input).



Pin assignment is for Dual-in-Line Package.

Figure 1. Pin Assignment



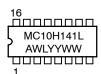
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#### **MARKING DIAGRAMS\***

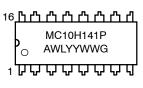






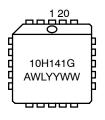


PDIP-16 P SUFFIX CASE 648





PLLC-20 FN SUFFIX CASE 775



A = Assembly Location

WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<sup>\*</sup>For additional marking information, refer to Application Note AND8002/D.

**Table 2. MAXIMUM RATINGS** 

Symbol	Characteristic	Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current - Continuous - Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 3. ELECTRICAL CHARACTERISTICS ( $V_{EE}$  = -5.2 V  $\pm 5\%$  (Note 1)

		<b>0</b> °		<b>25</b> °		<b>75</b> °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Power Supply Current	-	112	-	102	-	112	mA
l <sub>inH</sub>	Input Current High Pins 5,6,9,11,12,13 Pins 7,10 Pin 4	- - -	405 416 510	- - -	255 260 320	- - -	255 260 320	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V <sub>IL</sub>	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

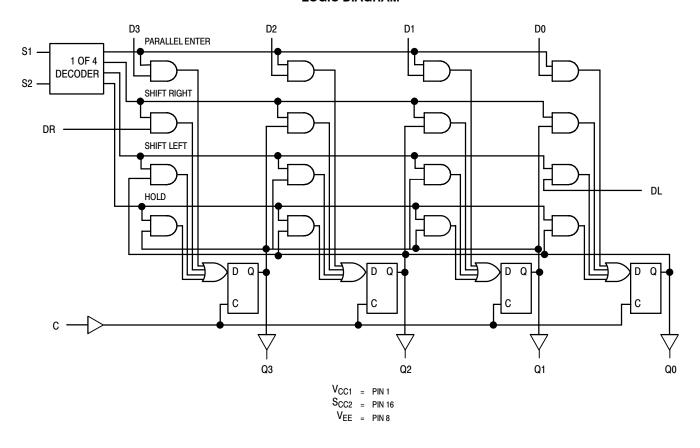
<sup>1.</sup> Each MECL 10H™ series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to −2.0 V.

**Table 4. AC PARAMETERS** 

t <sub>pd</sub>	Propagation Delay	1.0	2.0	1.0	2.0	1.1	2.1	ns
t <sub>hold</sub>	Hold Time – Data, Select	1.0	-	1.0	-	1.0	-	ns
t <sub>set</sub>	Set-up Time Data Select	1.5 3.0	- -	1.5 3.0	- -	1.5 3.0	- -	ns
t <sub>r</sub>	Rise Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
t <sub>f</sub>	Fall Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
f <sub>shift</sub>	Shift Frequency	250	_	250	_	250	-	MHz

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### **LOGIC DIAGRAM**



#### **APPLICATION INFORMATION**

The MC10H141 is a four-bit universal shift register which performs shift left, or shift right, serial/parallel in, and serial/parallel out operations with no external gating. Inputs S1 and S2 control the four possible operations of the register without external gating of the clock. The flip-flops shift

information on the positive edge of the clock. The four operations are stop shift, shift left, shift right, and parallel entry of data. The other six inputs are all data type inputs; four for parallel entry data, and one for shifting in from the left (DL) and one for shifting in from the right (DR).

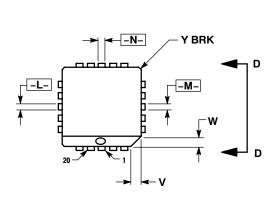
#### **ORDERING INFORMATION**

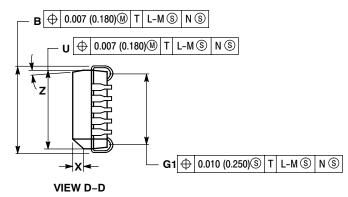
Device	Package	Shipping <sup>†</sup>	
MC10H141FN	PLLC-20	46 Units / Rail	
MC10H141FNG	PLLC-20 (Pb-Free)	46 Units / Rail	
MC10H141FNR2	PLLC-20	500 / Tape & Reel	
MC10H141FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel	
MC10H141L	CDIP-16	25 Unit / Rail	
MC10H141P	PDIP-16	25 Unit / Rail	
MC10H141PG	PDIP-16 (Pb-Free)	25 Unit / Rail	

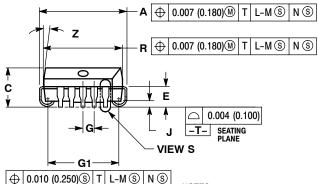
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

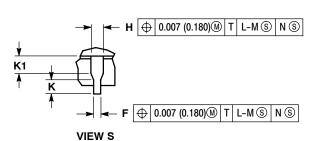
#### PACKAGE DIMENSIONS

#### **20 LEAD PLLC** CASE 775-02 **ISSUE E**









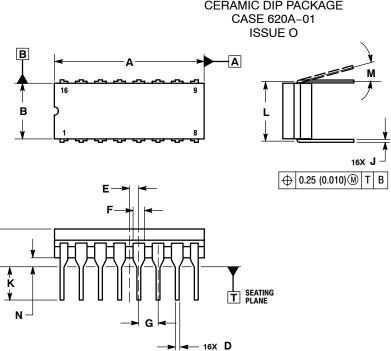
- NOTES:
  1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. DIMENSIONS IN INCHES.
  3. DATUMS -L., -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

- PARTING LINE.
  4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM —T-, SEATING PLANE.
  5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
  6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- PLASTIC BODY.
  7. DIMENSION H DOES NOT INCLUDE DAMBAR DIMIENSION H DUES NOT INCLUDE DAMBAR
  PROTRUSION OR INTRUSION. THE DAMBAR
  PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION
  TO BE GREATER THAN 0.037 (0.940). THE DAMBAR
  INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO
  BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2°	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

#### **PACKAGE DIMENSIONS**

#### CDIP-16 **L SUFFIX** CERAMIC DIP PACKAGE CASE 620A-01 ISSUE O

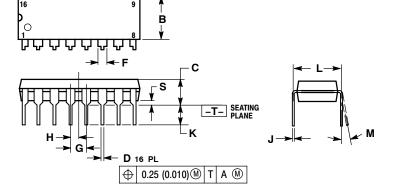


⊕ 0.25 (0.010) M T A

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY
- BODY.
  THIS DRAWING REPLACES OBSOLETE
  CASE OUTLINE 620-10.

	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
M	0 °	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

#### PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



-A-

#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: INCH.

  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

  5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIM	IETERS			
DIM	MIN MAX		MIN	MAX			
Α	0.740	0.770	18.80	19.55			
В	0.250	0.270	6.35	6.85			
С	0.145	0.175	3.69	4.44			
D	0.015	0.021	0.39	0.53			
F	0.040	0.70	1.02	1.77			
G	0.100	BSC	2.54	BSC			
Н	0.050	0.050 BSC		BSC			
J	0.008	0.015	0.21	0.38			
K	0.110	0.130	2.80	3.30			
L	0.295	0.305	7.50	7.74			
M	0°	10°	0°	10 °			
S	0.020	0.040	0.51	1.01			

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